



**S6AC THRU S6MC**

Reverse Voltage - 50 to 1000 Volts Forward Current - 6.0 Ampere

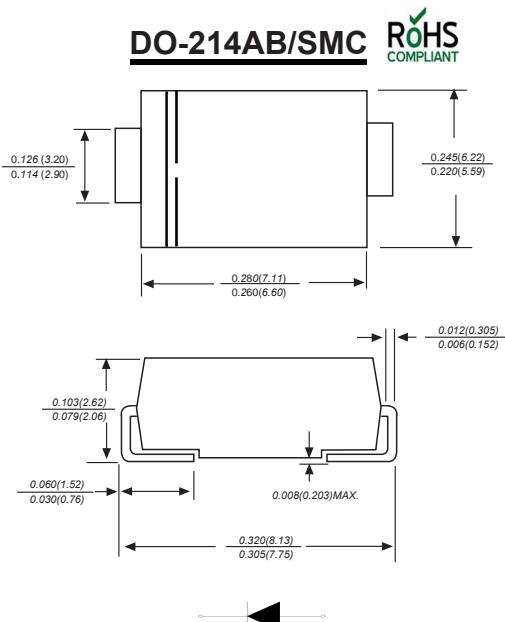
## SURFACE MOUNT GENERAL RECTIFIER

### Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Low reverse leakage
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:  
250 °C/10 seconds at terminals

### Mechanical Data

Case': JEDEC DO-214AB/SMC molded plastic body  
 Terminals': Solderable per MIL-STD-750, Method 2026A  
 Polarity': Polarity symbol marking on body  
 Mounting Position': Any  
 Weight : 0.0007 ounce, 0.25 grams



Dimensions in inches and (millimeters)

### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	S6AC	S6BC	S6DC	S6GC	S6JC	S6KC	S6MC	UNITS
Marking Code		MDD S6AC	MDD S6BC	MDD S6DC	MDD S6GC	MDD S6JC	MDD S6KC	MDD S6MC	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at TL=75°C	I <sub>(AV)</sub>					6.0			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				200				A
Maximum instantaneous forward voltage at 6.0A	V <sub>F</sub>				1.2				V
Maximum DC reverse current TA=25°C at rated DC blocking voltage TA=125°C	I <sub>R</sub>				10		100.0		µA
Typical junction capacitance (NOTE 1)	C <sub>J</sub>				60.0				pF
Typical thermal resistance (NOTE 2)	R <sub>θJA</sub>				10.0				°C/W
Operating junction and storage temperature range	T <sub>J,T<sub>STG</sub></sub>				-55 to +150				°C

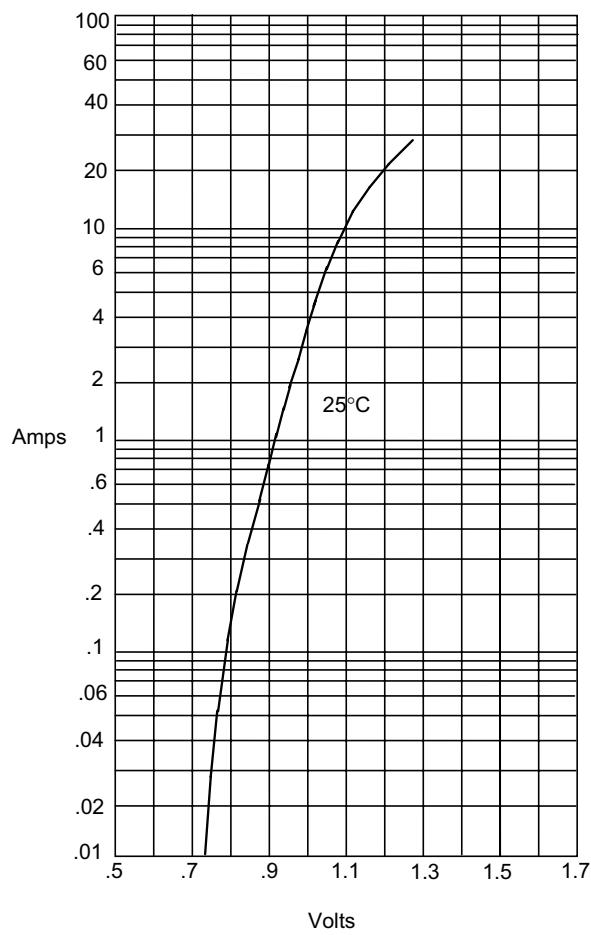
\*Pulse test: Pulse width 200 µsec, Duty cycle 2%

Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.



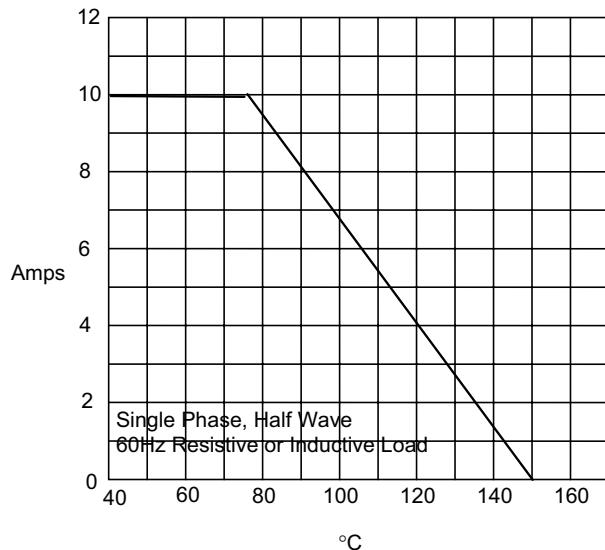
## Typical Characteristics

Figure 1  
Typical Forward Characteristics



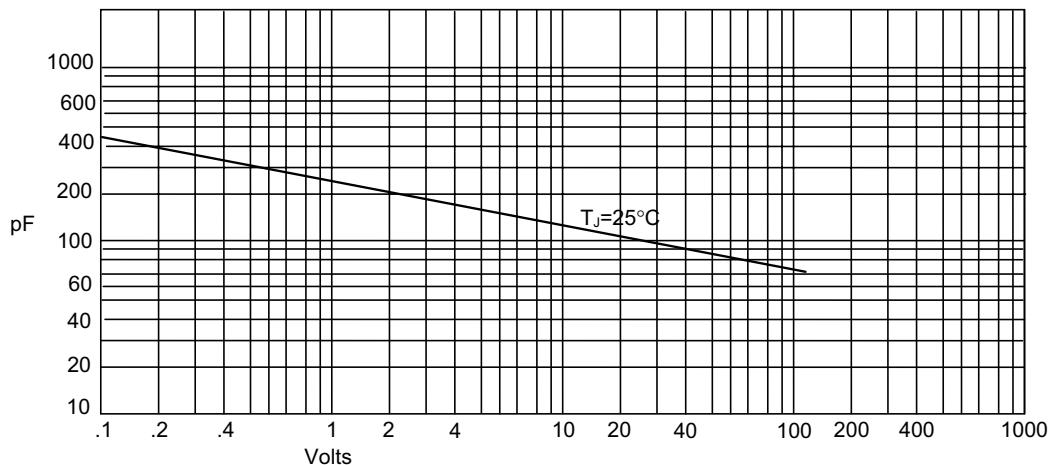
Instantaneous Forward Current - Amperes versus  
Instantaneous Forward Voltage - Volts

Figure 2  
Forward Derating Curve



Average Forward Rectified Current - Amperes versus  
Case Temperature - °C

Figure 3  
Junction Capacitance



Junction Capacitance - pF versus  
Reverse Voltage - Volts

The curve above is for reference only.

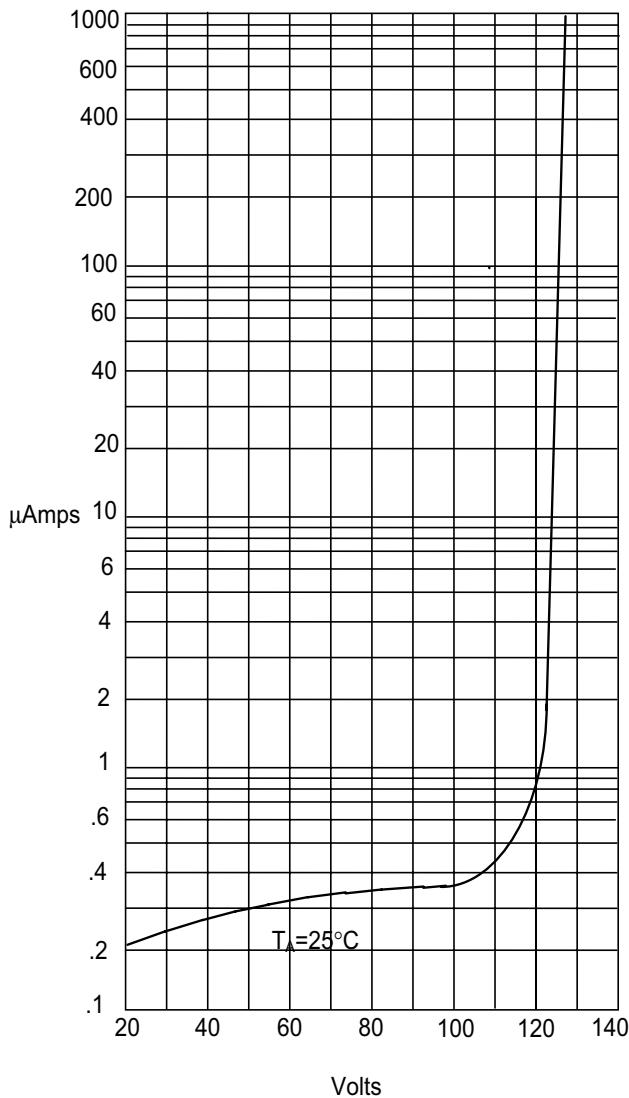


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Reverse Voltage - 50 to 1000 Volts Forward Current - 6.0 Ampere

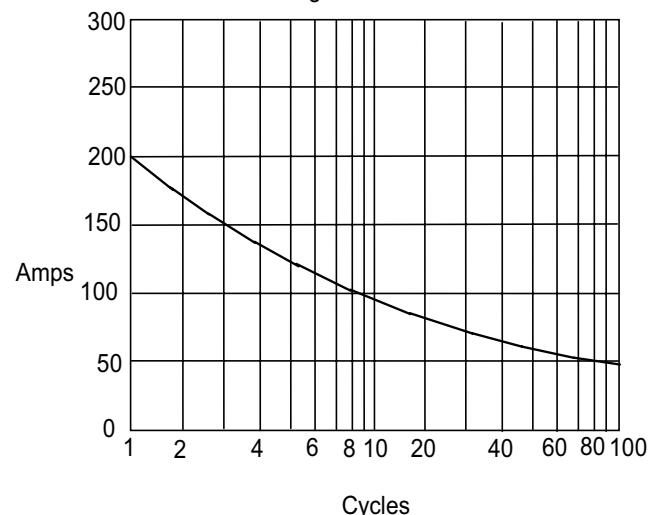
## Typical Characteristics

Figure 4  
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperes versus  
Percent Of Rated Peak Reverse Voltage - Volts

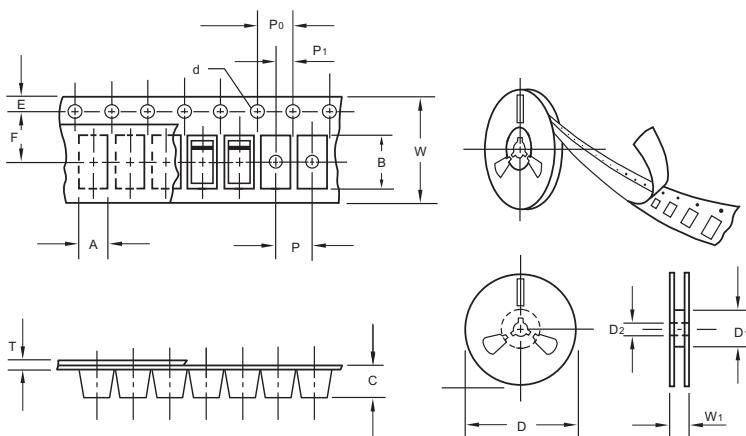
Figure 5  
Peak Forward Surge Current



Peak Forward Surge Current - Amperes versus  
Number Of Cycles At 60Hz - Cycles

The curve above is for reference only.

## Packing information



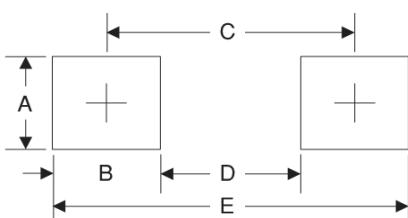
Item	Symbol	Tolerance	SMC
Carrier width	A	0.1	6.15
Carrier length	B	0.1	8.41
Carrier depth	C	0.1	2.42
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D <sub>1</sub>	min	50.00
Feed hole diameter	D <sub>2</sub>	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	7.50
Punch hole pitch	P	0.1	8.00
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00
Embossment center	P <sub>1</sub>	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	16.00
Reel width	W <sub>1</sub>	1.0	16.50

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

## Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA, (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMC	13"	3,000	4.0	6000	190*190*41	330	365*365*340	42000	14.0

## Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	4.3	0.170
B	4.1	0.160
C	7.9	0.311
D	3.8	0.150
E	12	0.472

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